

## 20 A, 600 V short-circuit rugged IGBT

Datasheet - production data

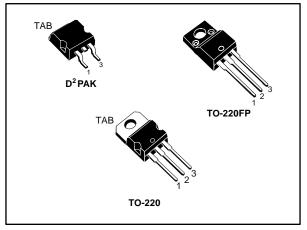
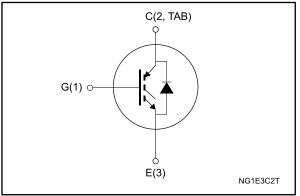


Figure 1: Internal schematic diagram



This is information on a product in full production.

## **Features**

- Low on voltage drop (V<sub>CE(sat)</sub>)
- Low CRES / CIES ratio (no cross-conduction susceptibility)
- Short-circuit withstand time 10 µs
- IGBT co-packaged with ultrafast freewheeling diode

## **Applications**

- High frequency inverters
- Motor drives

## Description

These devices are very fast IGBTs developed using advanced PowerMESH™ technology. This process guarantees an excellent trade-off between switching performance and low on-state behavior.

## Table 1: Device summary

Order code	Marking	Package	Packing		
STGB19NC60KDT4	GB19NC60KD	D²PAK	Tape and reel		
STGF19NC60KD	GF19NC60KD	TO-220FP	Tuba		
STGP19NC60KD	GP19NC60KD	TO-220	Tube		

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## Contents

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## 1 Electrical ratings

Cumula a l	Devenueter	Value	•	Unit
Symbol	Parameter	D <sup>2</sup> PAK, TO-220	TO-220FP	Unit
VCES	Collector-emitter voltage ( $V_{GE} = 0 V$ )	600		V
lc <sup>(1)</sup>	Continuous collector current at $T_c = 25 \ ^{\circ}C$	35	16	А
IC( )	Continuous collector current at Tc = 100 °C	20	10	А
Icl <sup>(2)</sup>	Turn-off latching current	75		А
Icp <sup>(3)</sup>	Pulsed collector current	75		А
Vge	Gate-emitter voltage	±20		V
lF	Diode RMS forward current at Tc= 25 °C	20		А
IFSM	Surge non repetitive forward current $t_{p}$ = 10 ms sinusoidal	50		А
Ртот	Total dissipation at $T_c = 25 \ ^{\circ}C$	125	32	W
Viso	Insulation withstand voltage (RMS) from all three leads to external heat-sink (t=1 s; $T_c$ = 25 °C)	2500		V
t <sub>scw</sub>	Short-circuit withstand time V <sub>CE</sub> = 300 V, T <sub>j</sub> = 125 °C, R <sub>G</sub> = 10 $\Omega$ , V <sub>GE</sub> = 12 V	10		μs
T <sub>stg</sub>	Storage temperature range	- 55 to 150		°C
TJ	Operating junction temperature range	- 55 10 1	50	C

### Table 2: Absolute maximum ratings

### Notes:

<sup>(1)</sup>Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

 $\label{eq:Vclamp} \begin{array}{l} ^{(2)} V_{clamp} = 80 \ \% \ V_{CES}, \ V_{GE} = 15 \ V, \ R_G = 10 \ \Omega, \ T_J = 150 \ ^\circ C. \end{array}$ 

### Table 3: Thermal data

Symbol Parameter		Value	Unit	
Symbol	Farameter	D2PAK, TO-220	TO-220FP	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case IGBT 1 3.9		3.9	
R <sub>thj-case</sub>	Thermal resistance junction-case diode	3	5.6	°C/W
Rthj-amb	Thermal resistance junction-ambient	62.5		



## 2 Electrical characteristics

 $T_C$  = 25 °C unless otherwise specified

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)</sub> CES	Collector-emitter breakdown voltage	Ic = 1 mA, V <sub>GE</sub> = 0 V	600			V
	Collector-emitter saturation	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 12 \text{ A}$		2.0	2.75	
V <sub>CE(sat)</sub>	voltage	$V_{GE} = 15 \text{ V}, I_C = 12 \text{ A},$ $T_C= 125 \text{ °C}$		1.65		V
V <sub>GE(th)</sub>	Gate threshold voltage	$V_{CE} = V_{GE}$ , $I_C = 250 \ \mu A$	4.5		6.5	V
		$V_{CE} = 600 \text{ V}, \text{ V}_{GE} = 0 \text{ V}$			150	μΑ
ICES Collector cut-off current		$V_{CE}$ =600 V, $V_{GE}$ = 0 V, T <sub>C</sub> = 125 °C <sup>(1)</sup>			1	mA
I <sub>GES</sub>	Gate-emitter leakage current	$V_{CE} = 0 V, V_{GE} = \pm 20 V$			±100	nA

## Table 4: Static characteristics

### Notes:

<sup>(1)</sup>Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance		-	1170	-	
Coes	Output capacitance	V <sub>CE</sub> = 25 V, f = 1 MHz,	-	127	-	рF
C <sub>res</sub>	Reverse transfer capacitance	V <sub>GE</sub> = 0 V	-	28	-	Ρ.
Qg	Total gate charge	$V_{CE} = 480 \text{ V}, I_{C} = 12 \text{ A},$	-	55	-	
Qge	Gate-emitter charge	V <sub>GE</sub> = 0 to 15 V (see <i>Figure 20:</i> " <i>Gate</i>	-	11	-	nC
Q <sub>gc</sub>	Gate-collector charge	charge test circuit")	-	26	-	

### Table 5: Dynamic characteristics

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# STGB19NC60KDT4, STGF19NC60KD, STGP19NC60KD

## **Electrical characteristics**

	Table 6: Switching on/off (Inductive Ioad)						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t <sub>d(on)</sub>	Turn-on delay time	V <sub>CC</sub> = 480 V, I <sub>C</sub> = 12 A,	-	30	-	ns	
tr	Current rise time	R <sub>G</sub> = 10 Ω, V <sub>GF</sub> = 15 V	-	8	-	ns	
(di/dt) <sub>on</sub>	Turn-on current slope	<ul> <li>V<sub>GE</sub> = 15 V</li> <li>(see Figure 19: " Test circuit for inductive load switching" and Figure 21: " Switching waveform")</li> </ul>		1450	-	A/µs	
t <sub>d(on)</sub>	Turn-on delay time	Vcc = 480 V, Ic = 12 A,	-	30	-	ns	
tr	Current rise time	R <sub>G</sub> = 10 Ω, V <sub>GE</sub> = 15 V, T <sub>C</sub> =125 °C	-	8	-	ns	
(di/dt) <sub>on</sub>	Turn-on current slope	(see Figure 19: " Test circuit for inductive load switching" and Figure 21: " Switching waveform")	-	1380	-	A/µs	
$t_{r(Voff)}$	Off voltage rise time	$V_{CC} = 480 \text{ V}, I_C = 12 \text{ A},$	-	35	-	ns	
t <sub>d(off)</sub>	Turn-off delay time	$R_G = 10 \Omega, V_{GE} = 15 V$	-	105	-	ns	
t <sub>f</sub>	Current fall time	<ul> <li>(see Figure 19: " Test circuit for inductive load switching" and Figure 21: " Switching waveform")</li> </ul>		85	-	ns	
t <sub>r(Voff)</sub>	Off voltage rise time	V <sub>CC</sub> = 480 V, I <sub>C</sub> = 12 A,	-	65	-	ns	
t <sub>d(off)</sub>	Turn-off delay time	R <sub>G</sub> = 10 Ω, V <sub>GE</sub> = 15 V, T <sub>C</sub> =125 °C (see <i>Figure 19:</i> "	-	145	-	ns	
t <sub>f</sub>	Current fall time	Test circuit for inductive load switching" and Figure 21: " Switching waveform")	-	125	-	ns	

### Table 6: Switching on/off (inductive load)

## Table 7: Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E <sub>on</sub> <sup>(1)</sup>	Turn-on switching energy	Vcc = 480 V, Ic = 12 A,	-	165	-	μJ
E <sub>off</sub> <sup>(2)</sup>	Turn-off switching energy	$R_G$ = 10 Ω , $V_{GE}$ = 15 V (see Figure 19: "Test circuit for inductive load switching")	-	255	-	μJ
Ets	Total switching energy			420	-	μJ
Eon <sup>(1)</sup>	Turn-on switching energy	Vcc = 480 V, lc = 12 A, Rg = 10 Ω , Vge = 15 V,	-	250	-	μJ
E <sub>off</sub> <sup>(2)</sup>	Turn-off switching energy	T <sub>C</sub> =125 °C (see <i>Figure 19:</i> " <i>Test circuit for</i>	-	445	-	μJ
Ets	Total switching energy	inductive load switching")	-	695	-	μJ

## Notes:

 $^{(1)}\mbox{Including the reverse recovery of the diode.}$ 

 $^{\mbox{(2)}}\mbox{Including the tail of the collector current.}$ 



## **Electrical characteristics**

## STGB19NC60KDT4, STGF19NC60KD, Table 8: Collector-emitter diode

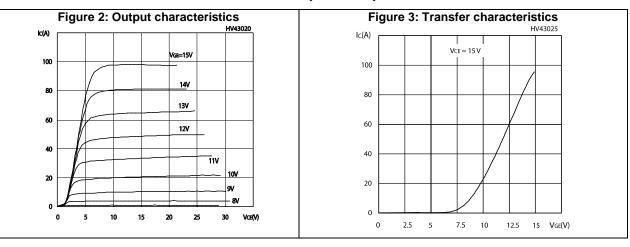
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
VF	Forward on voltage	I <sub>F</sub> =12 A	-	1.9	-	V
VF	Forward on-voltage	I⊧=12 A, Tc=125 °C	-	1.6	-	V
trr	Reverse recovery time			31	-	ns
Qrr	Reverse recovery charge	I <sub>F</sub> =12 A, V <sub>R</sub> =40 V, di/dt=100 A/µs (see <i>Figure 22: " Diode reverse</i>	-	30	-	nC
Irrm	Reverse recovery current	recovery waveform")		2	-	А
trr	Reverse recovery time		-	50	-	ns
Qrr	Reverse recovery charge	I <sub>F</sub> =12 A, V <sub>R</sub> =40 V, T <sub>C</sub> =125 °C, di/dt=100 A/µs (see <i>Figure 22: " Diode reverse</i>	-	70	-	nC
Irrm	Reverse recovery current	recovery waveform")	-	4	-	А

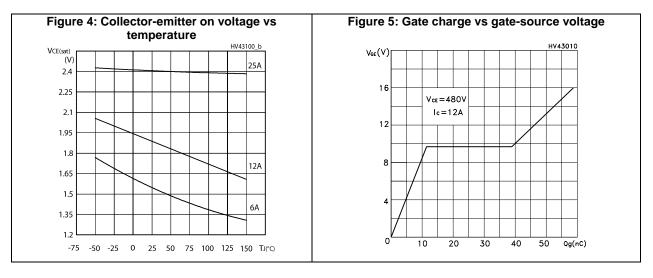
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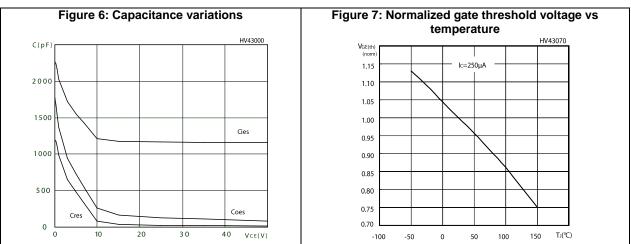


# STGB19NC60KDT4, STGF19NC60KD, STGP19NC60KD

## 2.1 Electrical characteristics (curves)





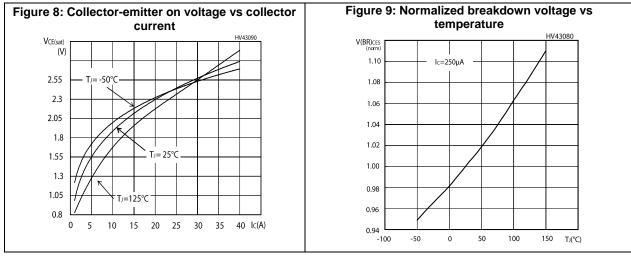


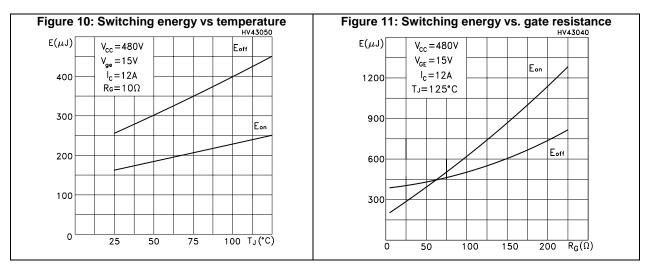
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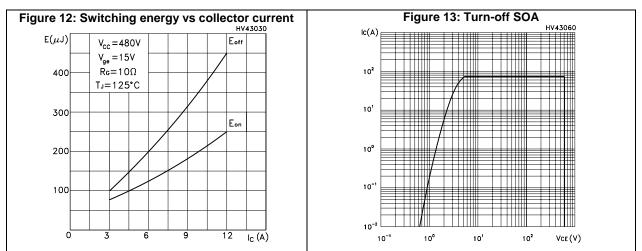
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### **Electrical characteristics**

### STGB19NC60KDT4, STGF19NC60KD, STGP19NC60KD







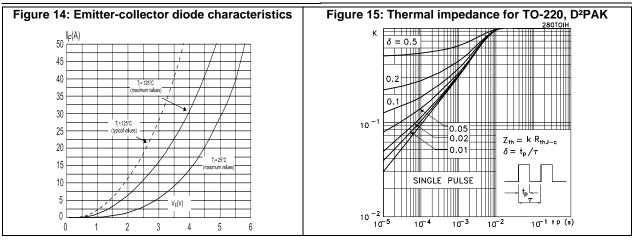
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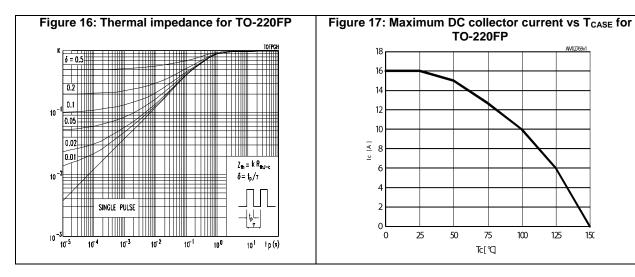
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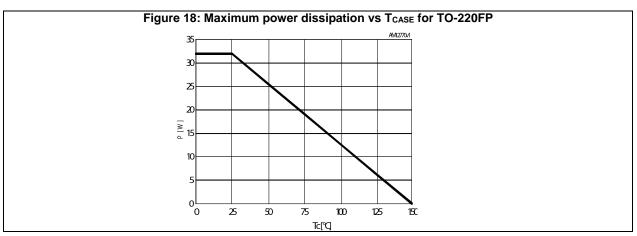


# STGB19NC60KDT4, STGF19NC60KD, STGP19NC60KD

### **Electrical characteristics**



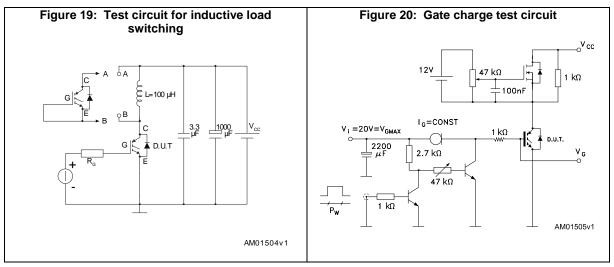


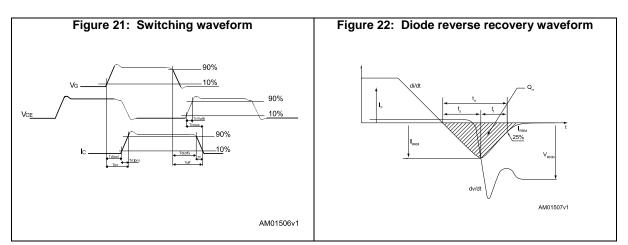


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### **Test circuits** 3









In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

## 4.1 D<sup>2</sup>PAK (TO-263) type A package information

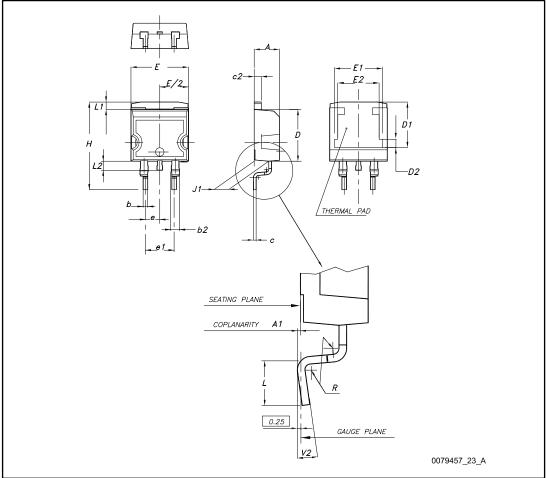


Figure 23: D<sup>2</sup>PAK (TO-263) type A package outline

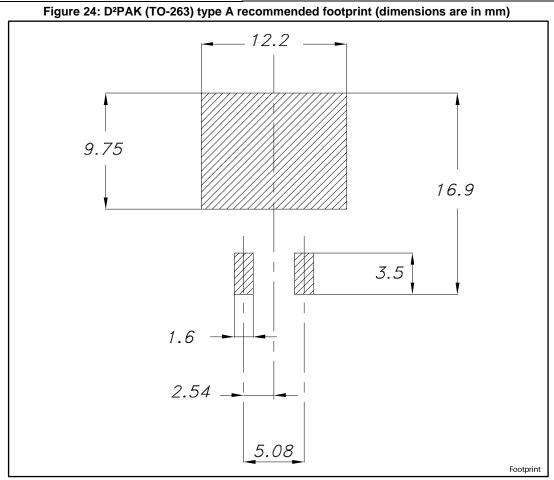


# STGB19NC60KDT4, STGF19NC60KD, STGP19NC60KD

Table 9: D <sup>2</sup> PAK (TO-263) type A package mechanical data					
Dim.		mm			
Dim.	Min.	Тур.	Max.		
А	4.40		4.60		
A1	0.03		0.23		
b	0.70		0.93		
b2	1.14		1.70		
С	0.45		0.60		
c2	1.23		1.36		
D	8.95		9.35		
D1	7.50	7.75	8.00		
D2	1.10	1.30	1.50		
E	10.00		10.40		
E1	8.50	8.70	8.90		
E2	6.85	7.05	7.25		
е		2.54			
e1	4.88		5.28		
Н	15.00		15.85		
J1	2.49		2.69		
L	2.29		2.79		
L1	1.27		1.40		
L2	1.30		1.75		
R		0.40			
V2	0°		8°		



# STGB19NC60KDT4, STGF19NC60KD, STGP19NC60KD

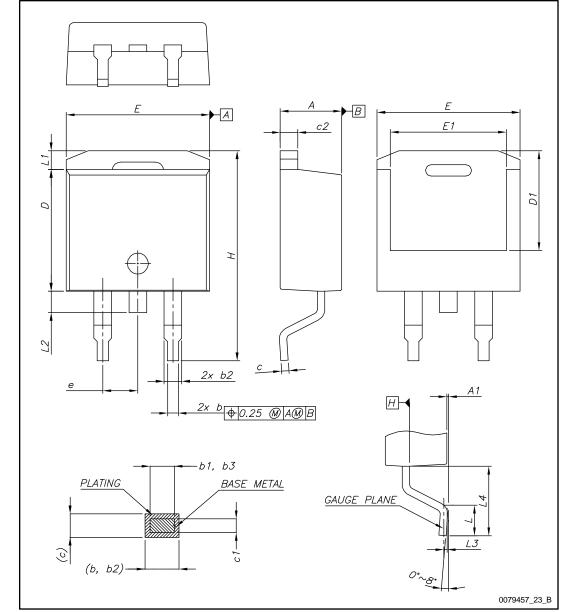




## 4.2

## D<sup>2</sup>PAK (TO-263) type B package information

Figure 25: D<sup>2</sup>PAK (TO-263) type B package outline





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## STGB19NC60KDT4, STGF19NC60KD, STGP19NC60KD

## Package information

Table 10: D <sup>2</sup> PAK (TO-263) type B mechanical data					
Dim		mm			
Dim.	Min.	Тур.	Max.		
A	4.36		4.56		
A1	0		0.25		
b	0.70		0.90		
b1	0.51		0.89		
b2	1.17		1.37		
b3	1.36		1.46		
С	0.38		0.694		
c1	0.38		0.534		
c2	1.19		1.34		
D	8.60		9.00		
D1	6.90		7.50		
E	10.15		10.55		
E1	8.10		8.70		
е		2.54 BSC			
Н	15.00		15.60		
L	1.90		2.50		
L1			1.65		
L2			1.78		
L3		0.25			
L4	4.78		5.28		



### STGB19NC60KDT4, STGF19NC60KD, STGP19NC60KD

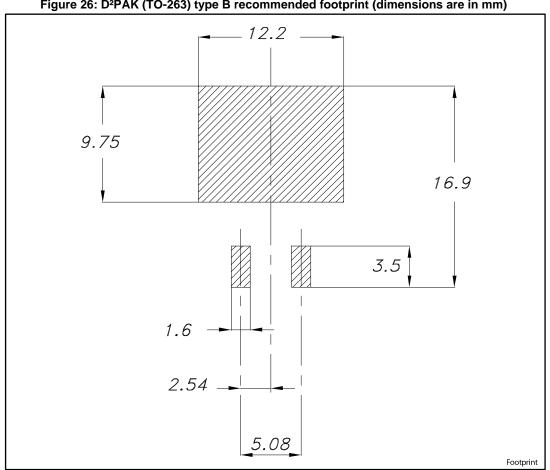
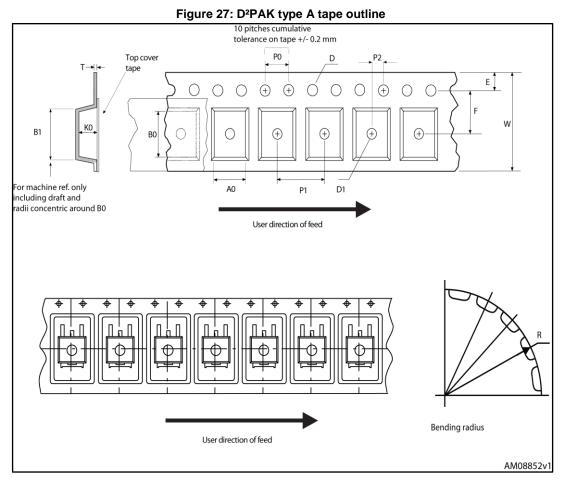


Figure 26: D<sup>2</sup>PAK (TO-263) type B recommended footprint (dimensions are in mm)

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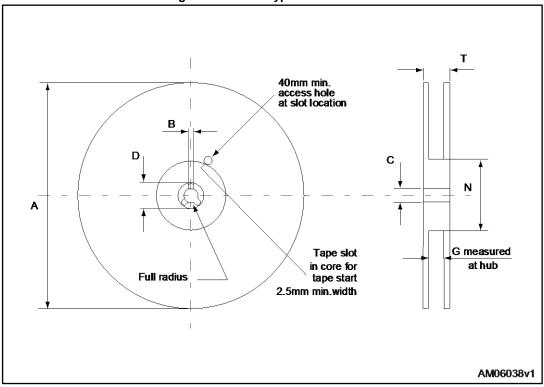


## 4.3 D<sup>2</sup>PAK type A packing information





### STGB19NC60KDT4, STGF19NC60KD, STGP19NC60KD



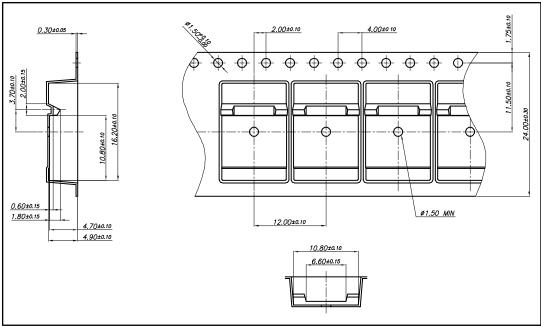
### Figure 28: D<sup>2</sup>PAK type A reel outline

### Table 11: D<sup>2</sup>PAK type A tape and reel mechanical data

Таре				Reel	
Dim.	m	ım	Dim.	m	ım
Dini.	Min.	Max.	Dini.	Min.	Max.
A0	10.5	10.7	А		330
B0	15.7	15.9	В	1.5	
D	1.5	1.6	С	12.8	13.2
D1	1.59	1.61	D	20.2	
E	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	Т		30.4
P0	3.9	4.1			
P1	11.9	12.1	Base q	uantity	1000
P2	1.9	2.1	Bulk quantity 100		1000
R	50				
Т	0.25	0.35			
W	23.7	24.3			

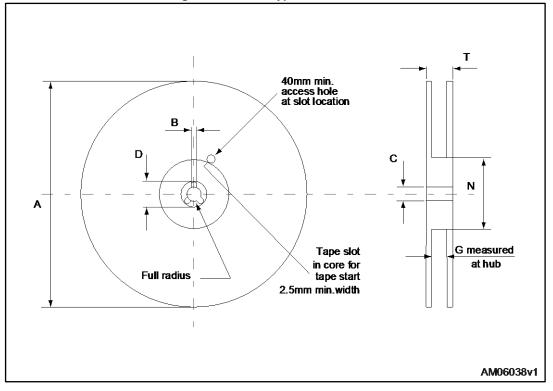


## 4.4 D<sup>2</sup>PAK type B packing information



## Figure 29: D<sup>2</sup>PAK type B tape outline

Figure 30: D<sup>2</sup>PAK type B reel outline



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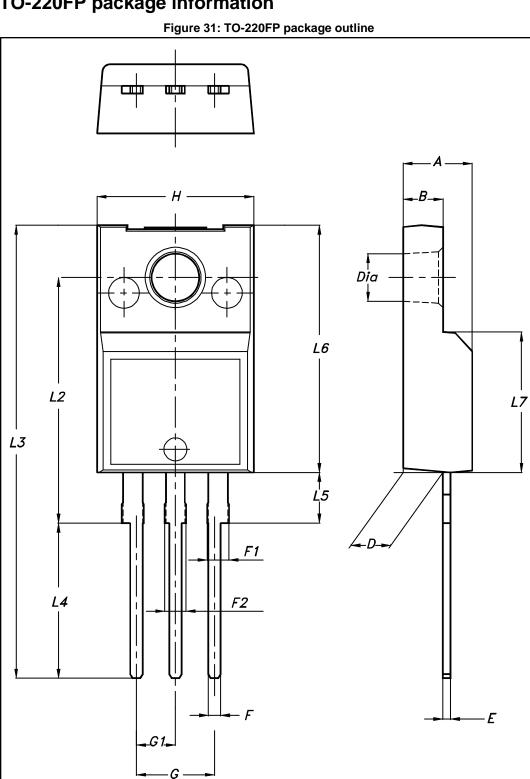
## STGB19NC60KDT4, STGF19NC60KD, STGP19NC60KD

Table 12: D-PAK type B reel mechanical data					
Dim.	r	nm			
	Min.	Max.			
А		330			
В	1.5				
С	12.8	13.2			
D	20.2				
G	24.4	26.4			
Ν	100				
Т		30.4			

## Table 12: D<sup>2</sup>PAK type B reel mechanical data



## 4.5 TO-220FP package information



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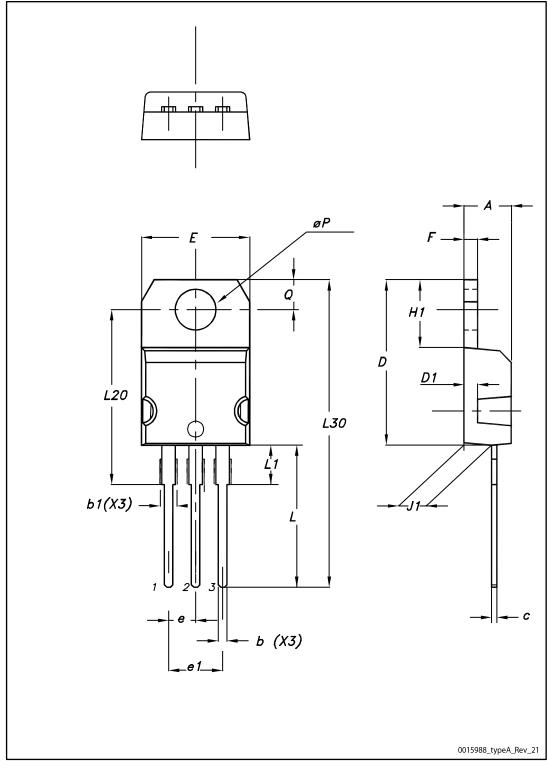
## STGB19NC60KDT4, STGF19NC60KD, STGP19NC60KD

Table 13: TO-220FP package mechanical data				
Dim.	mm			
	Min.	Тур.	Max.	
A	4.4		4.6	
В	2.5		2.7	
D	2.5		2.75	
E	0.45		0.7	
F	0.75		1	
F1	1.15		1.70	
F2	1.15		1.70	
G	4.95		5.2	
G1	2.4		2.7	
н	10		10.4	
L2		16		
L3	28.6		30.6	
L4	9.8		10.6	
L5	2.9		3.6	
L6	15.9		16.4	
L7	9		9.3	
Dia	3		3.2	



## 4.6 TO-220 type A package information

Figure 32: TO-220 type A package outline



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# STGB19NC60KDT4, STGF19NC60KD,

nformation	STGB19NC60KDT4, STGF19NC60KD, STGP19NC60KD				
Table 14: TO-220 type A package mechanical data					
Dim.	mm				
Dim.	Min.	Тур.	Max.		
A	4.40		4.60		
b	0.61		0.88		
b1	1.14		1.55		
С	0.48		0.70		
D	15.25		15.75		
D1		1.27			
E	10.00		10.40		
е	2.40		2.70		
e1	4.95		5.15		
F	1.23		1.32		
H1	6.20		6.60		
J1	2.40		2.72		
L	13.00		14.00		
L1	3.50		3.93		
L20		16.40			
L30		28.90			
øP	3.75		3.85		
Q	2.65		2.95		



## 5 Revision history

## Table 15: Document revision history

Date	Revision	Changes		
08-May-2008	1	Initial release		
28-May-2008	2	<ul> <li>Value on Table 3: Thermal resistance has been changed.</li> <li>Inserted Figure 16: Thermal impedance for TO-220, D<sup>2</sup>PAK and Figure 17: Thermal impedance for TO-220FP</li> </ul>		
31-Jul-2012	3	Added: Figure 18 and Figure 19 on page 8.		
17-Jul-2017	4	Modified internal schematic diagram on cover page Modified Table 2: "Absolute maximum ratings", Table 3: "Thermal data", and Table 4: "Static characteristics". Modified Figure 3: "Transfer characteristics", Figure 4: "Collector- emitter on voltage vs temperature" and Figure 8: "Collector-emitter on voltage vs collector current". Updated Section 4: "Package information". Minor text changes.		



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